

## Features

- Ultra Low Forward Voltage Drop
- Low Leakage Current
- Excellent High-Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- **Lead Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- Also Available in Green Molding Compound (Note 4)

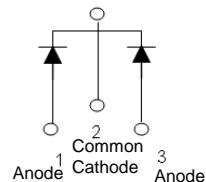
## Mechanical Data

- Case: TO263AB (D<sup>2</sup>PAK)
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 1.6 grams (Approximate)

TO263AB (D<sup>2</sup>PAK)



Top View



Package Pin Out Configuration

## Ordering Information (Notes 5)

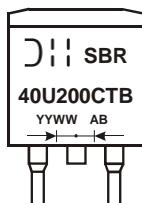


Part Number	Case	Packaging
SBR40U200CTB	TO263AB (D <sup>2</sup> PAK)	50 Pieces/Tube
SBR40U200CTB-G (Note 4)	TO263AB (D <sup>2</sup> PAK)	50 Pieces/Tube
SBR40U200CTB-13	TO263AB (D <sup>2</sup> PAK)	800/Tape & Reel
SBR40U200CTB-13-G (Note 4)	TO263AB (D <sup>2</sup> PAK)	800/Tape & Reel

Notes:

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR40U200CTB-G.
5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



SBR40U200CTB = Product Type Marking Code  
 AB = Foundry and Assembly Code (if applicable)  
 YYWW = Date Code Marking  
 YY = Year (ex: 15 = 2015)  
 WW = Week (01 - 53)

## Maximum Ratings (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$		
Working Peak Reverse Voltage	$V_{RWM}$	200	V
DC Blocking Voltage	$V_{RM}$		
Average Rectified Output Current @ $T_C = +100^\circ\text{C}$	$I_O$	40	A
Non-Repetitive Peak Forward Surge Current 8.3ms	$I_{FSM}$	240	A
Single Half Sine-Wave Superimposed on Rated Load			

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (per leg)			
Thermal Resistance Junction to Case (Note 6)	$R_{\theta JC}$	2	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	7	
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +175	$^\circ\text{C}$

## Electrical Characteristics (@ $T_A = +25^\circ\text{C}$ unless, otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (per leg)	$V_F$	-	0.85 0.70	0.93 0.75	V	$I_F = 20\text{A}, T_J = +25^\circ\text{C}$ $I_F = 20\text{A}, T_J = +125^\circ\text{C}$
Leakage Current (Note 7)	$I_R$	- -	- -	0.2 40	mA	$V_R = 200\text{V}, T_J = +25^\circ\text{C}$ $V_R = 200\text{V}, T_J = +125^\circ\text{C}$
Reverse Recovery Time	$t_{rr}$	-	38	50	nS	$I_F = 0.5\text{A}, I_R = 1\text{A},$ $I_{RR} = 0.25\text{A}$
		-	25	35		$I_F = 1\text{A}, V_R = 30\text{V}$ $di/dt = 100\text{A}/\mu\text{s}, T_J = +25^\circ\text{C}$

Notes: 6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.

7. Short duration pulse test used to minimize self-heating effect.

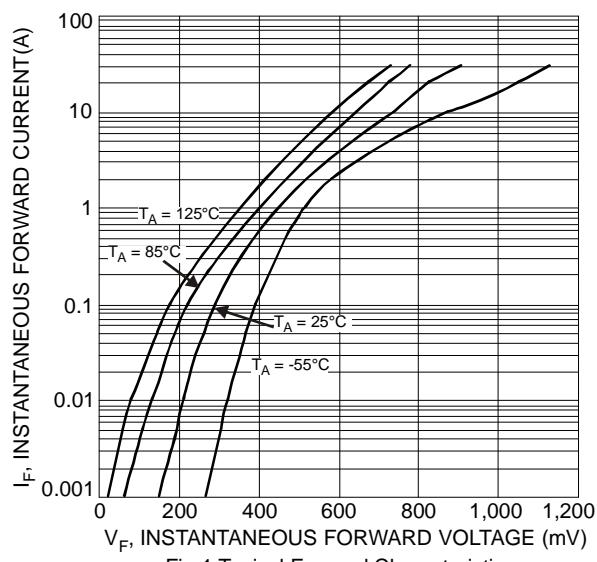


Fig. 1 Typical Forward Characteristics

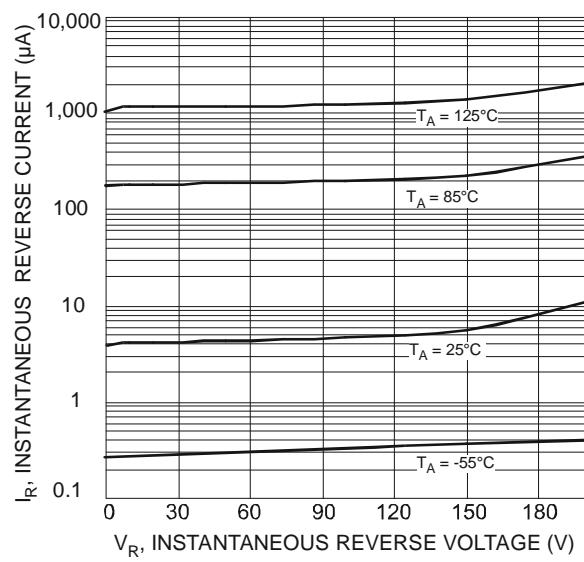


Fig. 2 Typical Reverse Characteristics

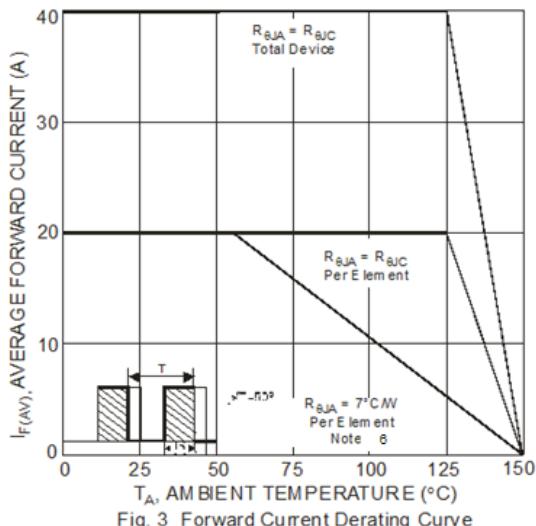
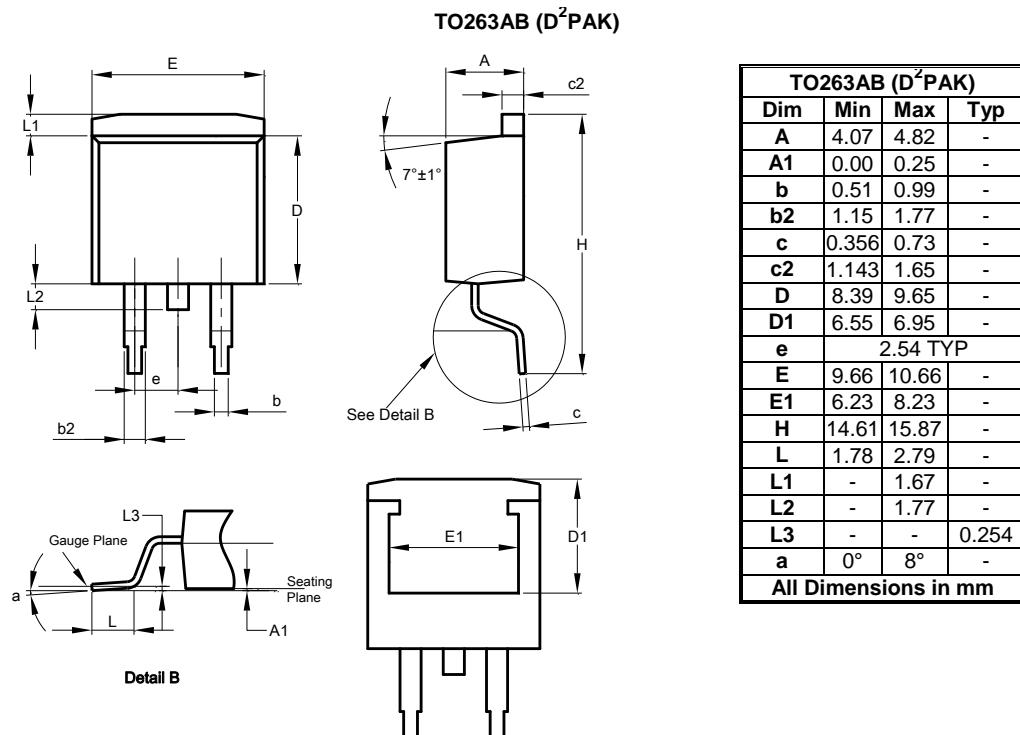


Fig. 3 Forward Current Derating Curve

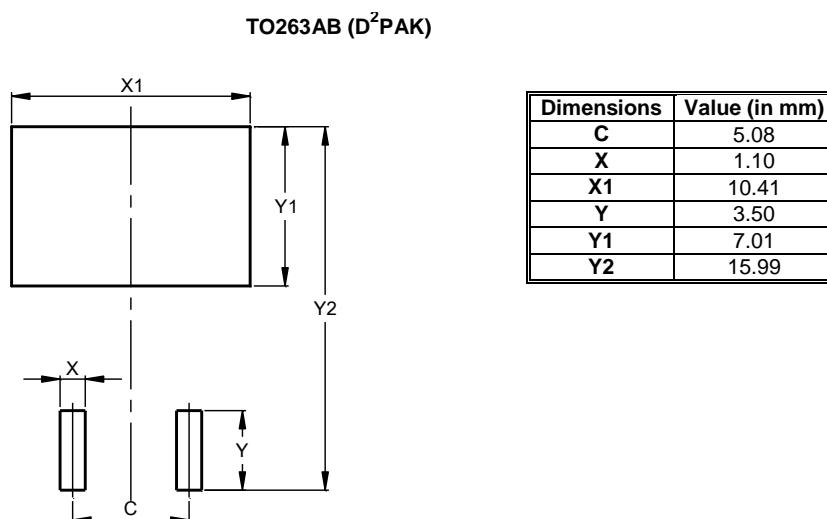
## Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



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